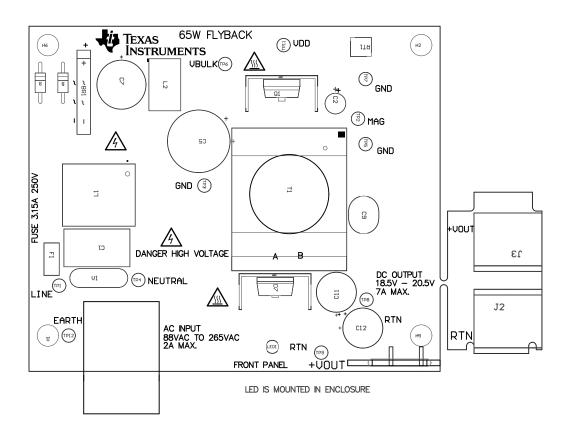
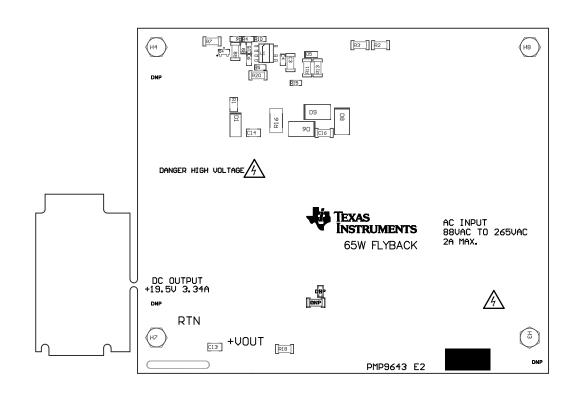
- ZZ2 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ4 These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.
- ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9643	REV: E2	SUN REV	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 15/04/	2014 09:49:37	,	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9643	REV: E2	SVN REV: Not In VersionControl		
		IGNORE ->	r l ay	Bottom Overla	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 15/04/	2014 09:49:38	3	TEXAS INSTRUMENTS	

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